



PATENT

UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/647,297

Group Art Unit: 1794

Filing Date: August 26, 2003

Examiner: Hai Vo

Applicants: Hyun HUH et al.

Title: POLISHING PAD CONTAINING EMBEDDED LIQUID MICROELEMENTS AND METHOD OF MANUFACTURING THE SAME

Attorney Docket: 47881-000003/US

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May 19, 2008

Randolph Building

401 Dulany Street

Alexandria, VA 22314

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06/02/2008

SUPPLEMENTAL AMENDMENT UNDER 35 U.S.C. §1.116

Sir:

In response to the Advisory Action mailed April 11, 2008, and the Final Office Action mailed January 18, 2008, the due date having been extended one (1) month to May 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims begins on page 2 of this Amendment.

Remarks begin on page 5 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	14	-	31	=	0
Independent	1	-	3	=	0